

Features

- wideband, 50 to 6000 MHz
- low insertion loss, 0.7 dB typ.
- miniature surface mount 0.15"x0.15"
- protected by US Patent, 7,012,486
- aqueous washable

Applications

- biasing amplifiers
- biasing of laser diodes
- biasing of active antennas



Generic photo used for illustration purposes only

CASE STYLE: GU1604

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Available Tape and Reel at no extra cost	
Reel Size	Devices/Reel
7"	20, 50, 100, 200, 500, 1000
13"	2000

Electrical Specifications

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		50		6000	MHz
Insertion Loss	50-500	—	0.2	0.8	dB
	500-3000	—	0.7	1.8	
	3000-6000	—	1.1	2.5	
Isolation (RF port to DC port) (RF & DC port to DC port)	50-500	38	52	—	dB
	500-3000	18	28	—	
	3000-6000	14	19	—	
VSWR	50-500	—	1.05	1.5	:1
	500-3000	—	1.1	1.3	
	3000-6000	—	1.2	2.2	

External C1(0.01μF) is required. See functional schematic and PCB layout.

Maximum Ratings

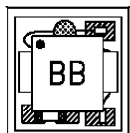
Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	30 dBm max.
Voltage at DC port	25 V max.
DC Current	200mA

Permanent damage may occur if any of these limits are exceeded.

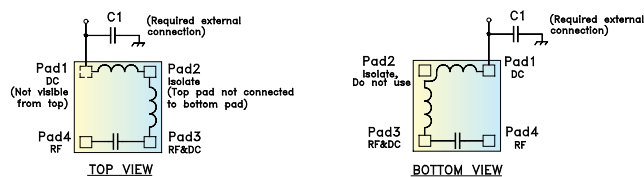
Pad Terminations

Function	Pad Number
RF	4
RF&DC	3
DC	1
ISOLATE (see PCB Layout)	2

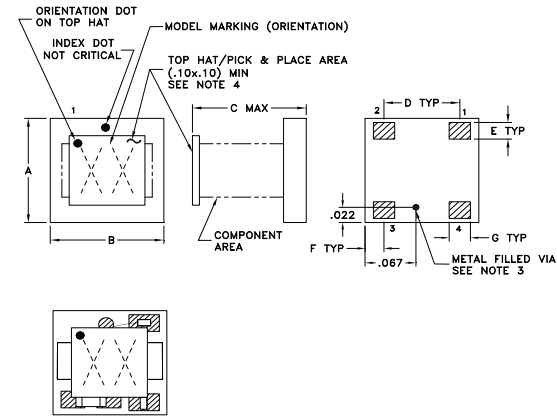
Product Marking



Functional Schematic



Outline Drawing

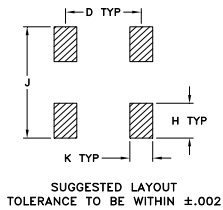


TOP VIEW OF "TCBT" SERIES MODELS

Notes:

- Must be isolated from external conductors on mounting surface. Suggested solder mask area is .025 x .025. At Mini-Circuits option via may be removed.
- Top-Hat total thickness: .013 inches MAX.

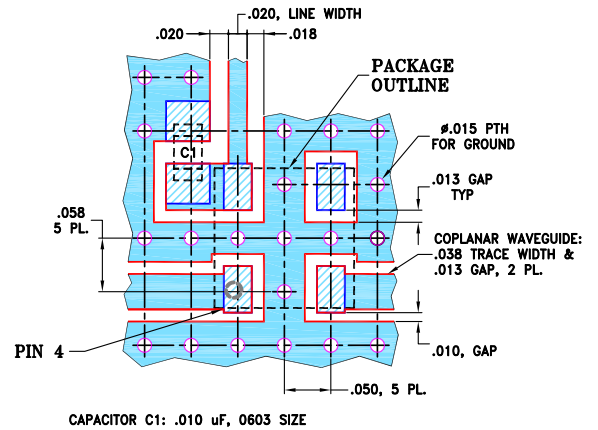
PCB Land Pattern



Outline Dimensions (inch/mm)

A	B	C	D	E	F
.150	.150	.150	.100	.030	.025
3.81	3.81	3.81	2.54	0.76	0.64
G	H	J	K	wt	
.028	.050	.160	.030	grams	
0.71	1.27	4.06	0.76	0.10	

Demo Board MCL P/N: TB-268 Suggested PCB Layout (PL-146)



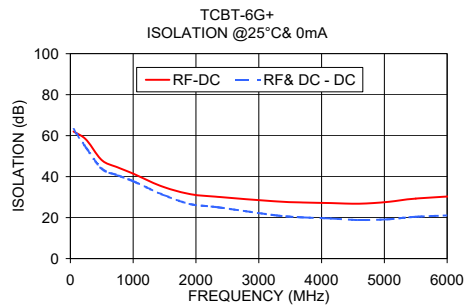
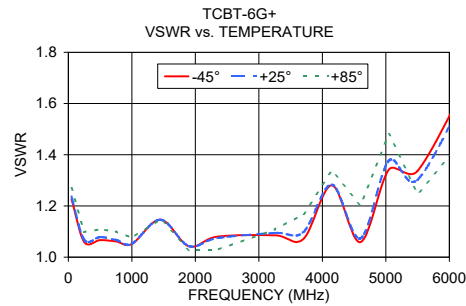
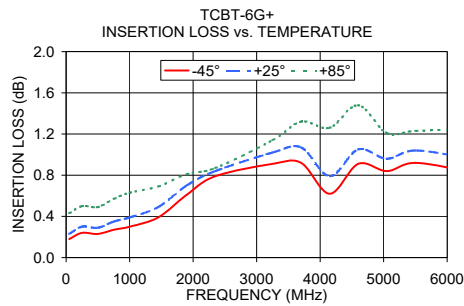
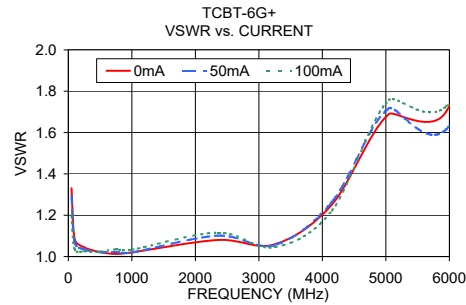
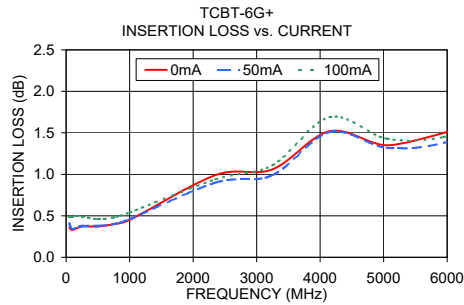
NOTES:

- COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.020±0.0015; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB) with temperature			VSWR (:1) with temperature			ISOLATION (dB) 0mA	
	-45°C	+25°C	+85°C	-45°C	+25°C	+85°C	RF - DC	RF & DC-DC
50.00	0.18	0.23	0.43	1.23	1.24	1.27	62.01	63.14
250.00	0.24	0.30	0.50	1.06	1.07	1.10	58.05	54.10
500.00	0.23	0.29	0.49	1.07	1.08	1.11	48.04	43.88
750.00	0.27	0.35	0.57	1.06	1.07	1.10	44.58	40.67
1000.00	0.30	0.39	0.63	1.05	1.05	1.08	41.47	37.79
1450.00	0.39	0.49	0.69	1.15	1.15	1.15	35.33	31.47
1900.00	0.61	0.70	0.81	1.04	1.04	1.03	31.51	26.67
2350.00	0.79	0.84	0.87	1.08	1.07	1.03	30.13	25.03
3250.00	0.91	1.02	1.14	1.09	1.09	1.11	27.98	21.20
3700.00	0.92	1.07	1.32	1.07	1.10	1.17	27.37	20.10
4150.00	0.62	0.79	1.26	1.28	1.28	1.34	27.10	19.55
4600.00	0.91	1.05	1.48	1.06	1.07	1.20	26.78	18.79
5050.00	0.84	0.96	1.21	1.34	1.38	1.48	27.64	19.18
5500.00	0.92	1.04	1.23	1.34	1.30	1.25	29.30	20.39
6400.00	0.83	0.96	1.25	1.74	1.70	1.51	31.01	21.50



Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

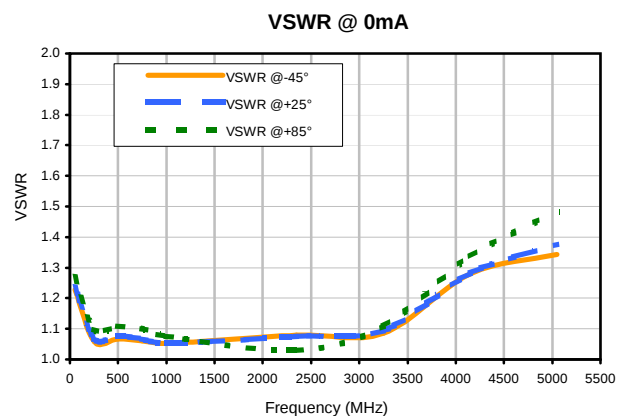
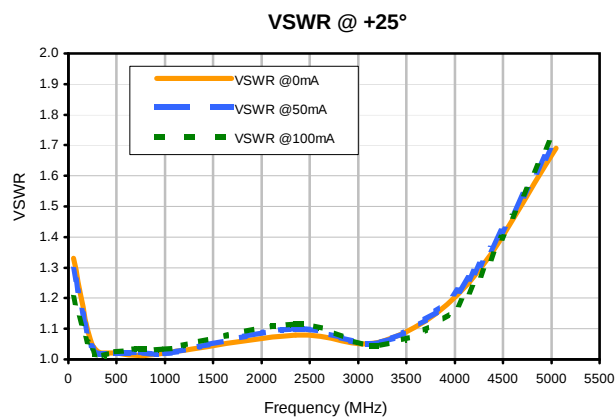
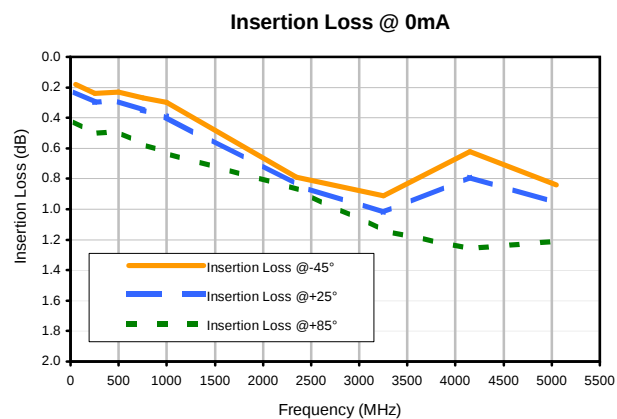
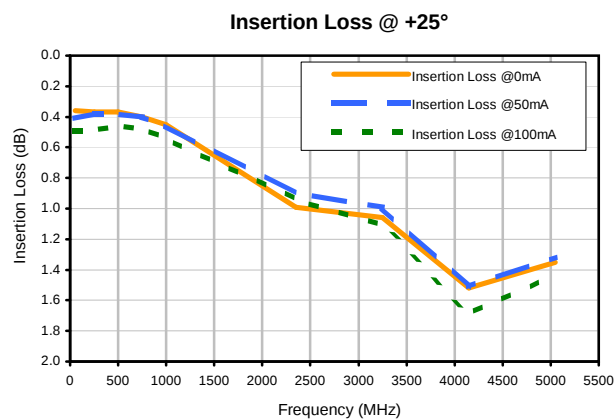
Typical Performance Data

FREQ. (MHz)	INSERTION LOSS (RF Port to RF&DC Port)						VSWR (:1)					
	(dB)											
	0mA	+25° 50mA	100mA	-45°	0mA +25°	+85°	0mA	+25° 50mA	100mA	-45°	0mA +25°	+85°
50	0.36	0.41	0.49	0.18	0.23	0.43	1.33	1.29	1.20	1.23	1.24	1.27
250	0.37	0.38	0.49	0.24	0.30	0.50	1.04	1.03	1.03	1.06	1.07	1.10
500	0.37	0.38	0.46	0.23	0.29	0.49	1.02	1.02	1.02	1.07	1.08	1.11
750	0.40	0.40	0.48	0.27	0.35	0.57	1.01	1.02	1.03	1.06	1.07	1.10
1000	0.45	0.46	0.54	0.30	0.39	0.63	1.02	1.02	1.03	1.05	1.05	1.08
2350	0.99	0.90	0.94	0.79	0.84	0.87	1.08	1.10	1.12	1.08	1.07	1.03
3250	1.06	0.99	1.11	0.91	1.02	1.14	1.06	1.06	1.05	1.09	1.09	1.11
4150	1.52	1.51	1.69	0.62	0.79	1.26	1.25	1.26	1.22	1.28	1.28	1.34
5050	1.35	1.32	1.43	0.84	0.96	1.21	1.69	1.72	1.76	1.34	1.38	1.48

Bias Tee , Surface Mount

Typical Performance Curves

TCBT-6G+



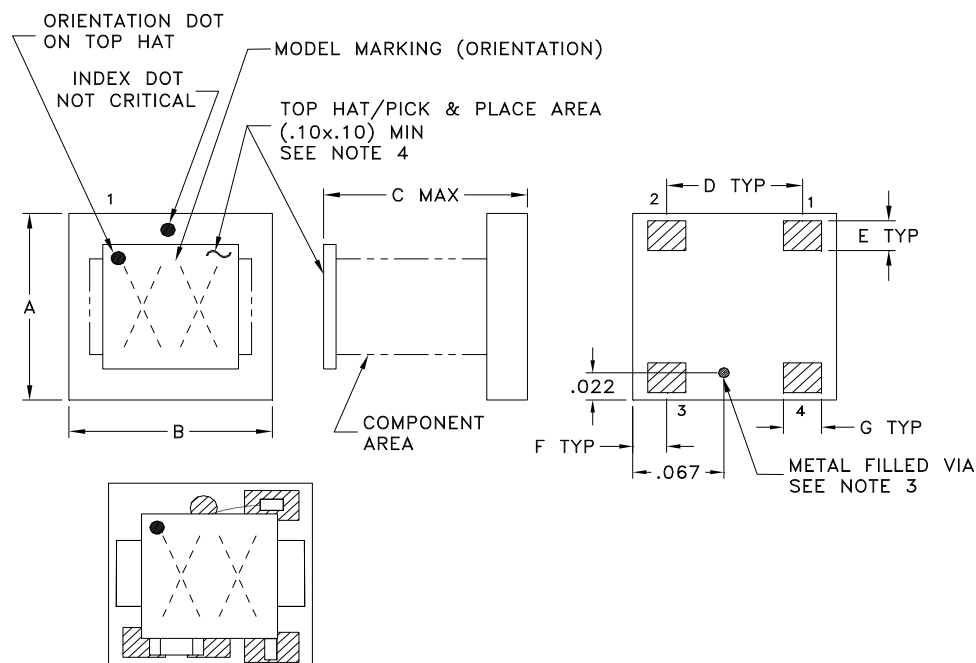
REV. X1
TCBT-6G+
061126
Page 1 of 1



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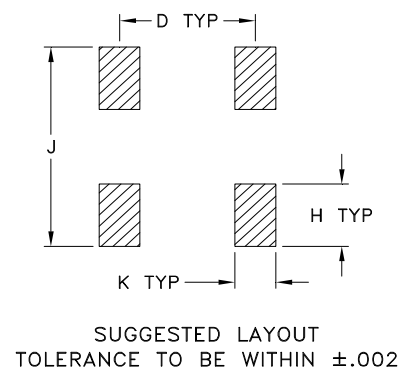
Outline Dimensions

GU1604



TOP VIEW OF "TCBT" SERIES MODELS

PCB Land Pattern



CASE #	A	B	C	D	E	F	G	H	J	K	WT.GRAMS
GU1604	.150 (3.81)	.150 (3.81)	.150 (3.81)	.100 (2.54)	.030 (.76)	.025 (.64)	.028 (.71)	.050 (1.27)	.160 (4.06)	.030 (.76)	.10

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

1. Open style, Ceramic Base.
2. Termination finish: Silver Palladium or Gold Over Nickel based on stock availability.
3. Must be isolated from external conductors on mounting surface. Suggested solder mask area is .025 x .025.
At Mini-Circuits option via may be removed.
4. Top-Hat total thickness: .013 inches MAX.
5. Orientation Dot on Top Hat corresponds to Pin #1.



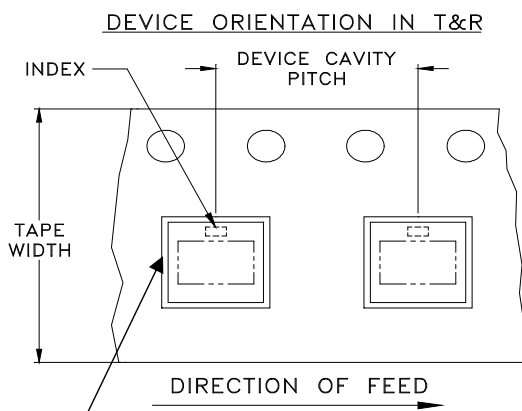
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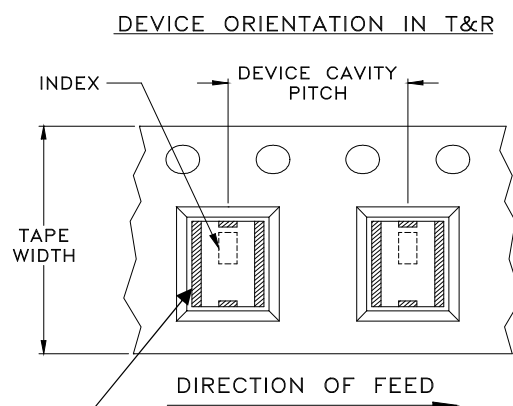
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RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F77



Note: The shape of the pocket may differ



Note: The location and shape of the metallization may differ

Applicable Case Styles

GU1604, GU1804, GU2644,
TT1618-2

Applicable Case Styles

MZ4532C, NM1812C,
NM1812C-1, NM1812C-2,
NM1812C-3, NM1812C-5,
NM1812C-6, NM3237

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
		13	Standard	2000

Note: Please Consult individual model data sheet to determine device per reel availability.

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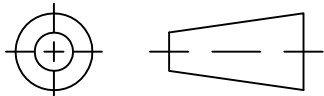
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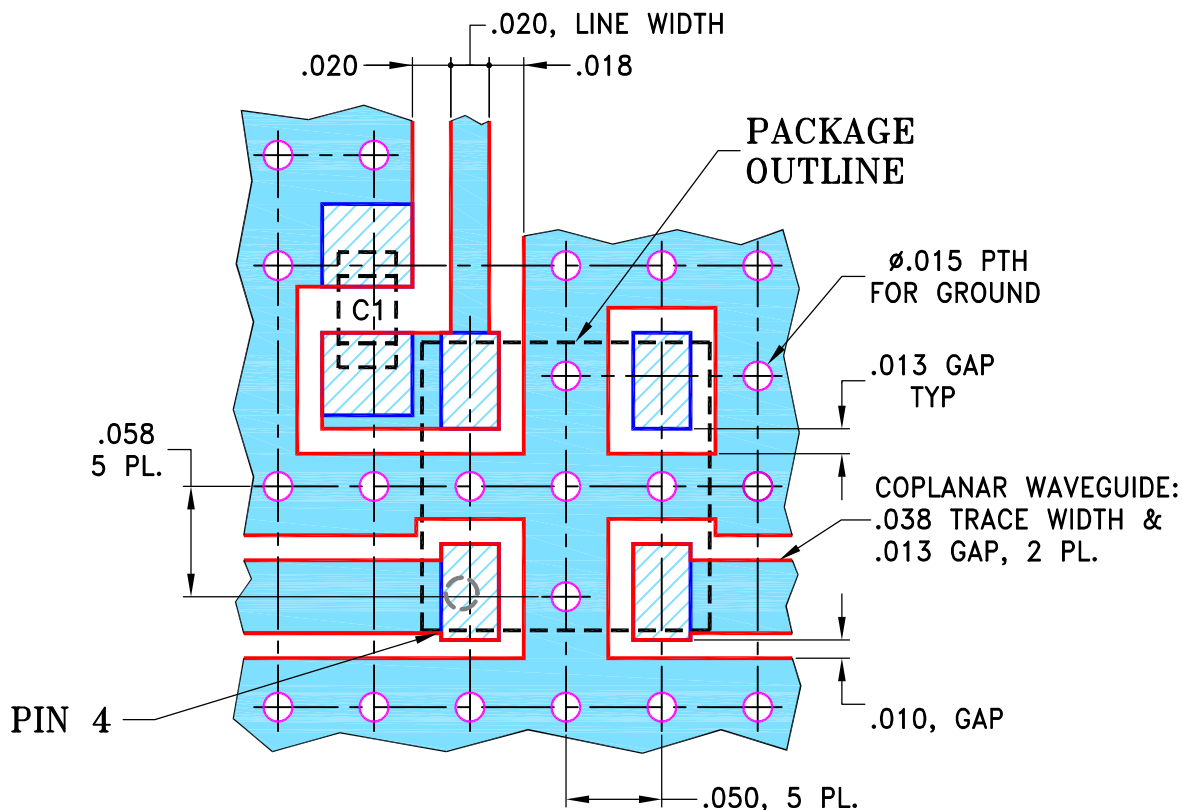
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
B	M102713	ADDED "...WITH SMOBC"	01/12/06	GF	IL
C	M103775	.010 uF WAS .010 mF	03/01/06	MMG	DJ
D	M154947	CHANGED PIN1 & PIN CONNECTION	02/03/16	ITG	DJ
E	M167305	CHANGED CASE STYLE & PIN CONNECT.	04/18/18	ITG	IG

SUGGESTED MOUNTING CONFIGURATION FOR GU1604 CASE STYLE, "04BT01" PIN CONNECTION



CAPACITOR C1: .010 uF, 0603 SIZE

NOTES:

1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS 0.020 ± 0.0015 ; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN AV	10/13/03
TOLERANCES ON:	CHECKED IL	10/23/03
2 PL DECIMALS $\pm$	APPROVED DJ	10/23/03
3 PL DECIMALS $\pm$.005		
ANGLES $\pm$		
FRACTIONS $\pm$		

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ASHEETA1.DWG REV:A DATE:01/12/95

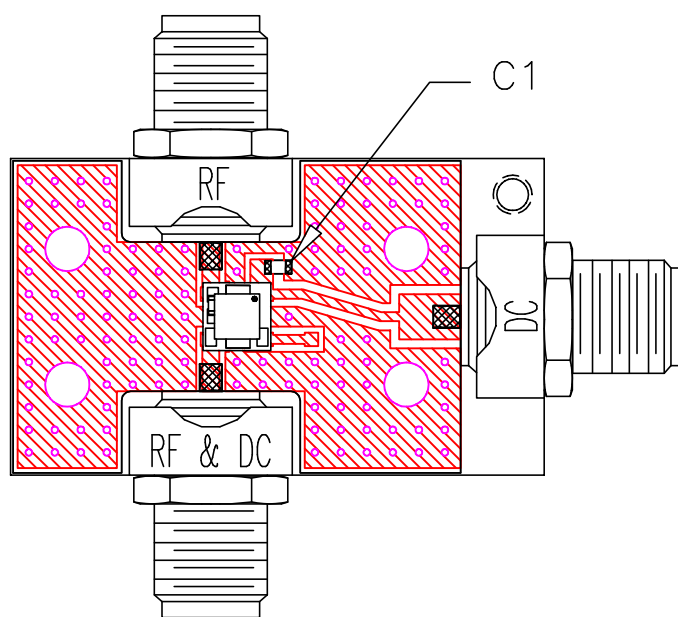


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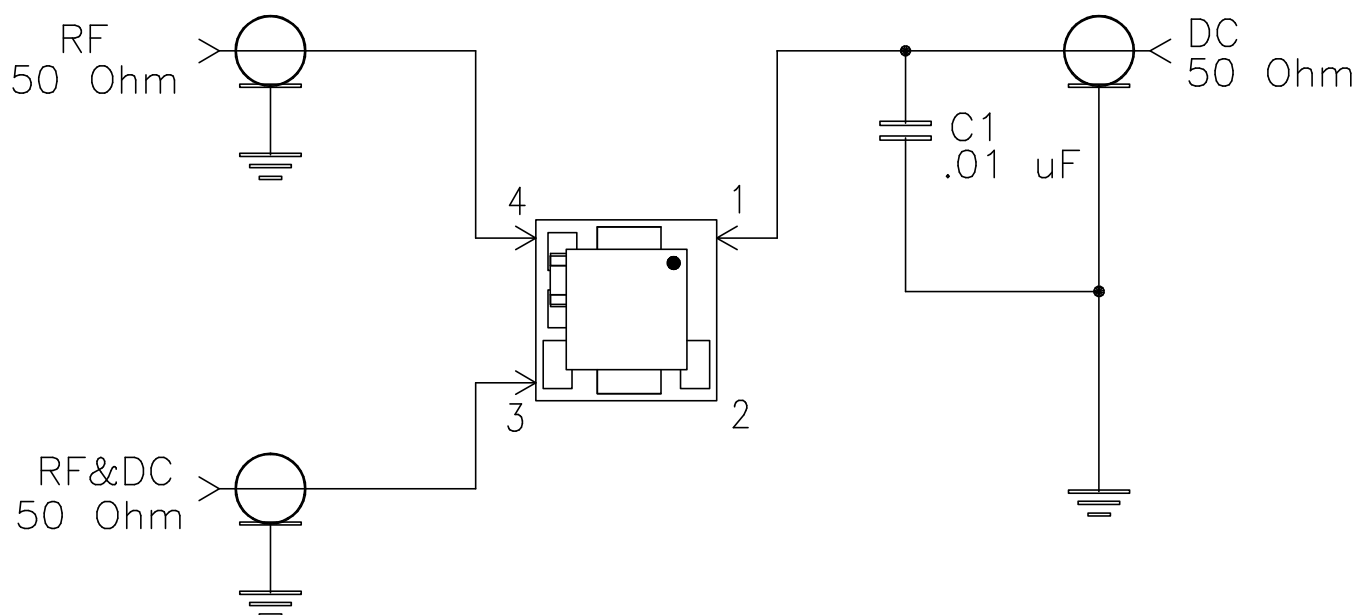
PL, 04BT01, GU1604, TCBT, TB-268

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-146	E
FILE:	98PL146	SCALE:	10:1
		SHEET:	1 OF 1

Evaluation Board and Circuit



TB-268



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent, Dielectric Constant=3.5, Thickness=.020 inch.

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Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215